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C. Moore

Attorney's Docket No.: 042390P10637

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of:

Thomas N. Marieb et al.

Application No.: 09/739,929

Filed: December 18, 2000

For: COPPER ALLOYS FOR
INTERCONNECTIONS HAVING
IMPROVED ELECTROMIGRATION
CHARACTERISTICS AND METHODS
OF MAKING SAME

Examiner: Hoang, Quoc D.

Art Unit: 2818

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If there are any additional charges, please charge Deposit Account No. 02-2666.

Respectfully submitted,

BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP

Dated: 10/15, 2002


Michael A. Bernadicou
Reg. No. 35, 934

12400 Wilshire Blvd.
Seventh Floor
Los Angeles, CA 90025-1026
(408) 720-8300

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Application Number	09/739,929
Filing Date	December 18, 2000
First Named Inventor:	Thomas N. Marieb et al.
Group Art Unit	2818
Examiner Name	Hoang, Quoc D.
Attorney Docket Number	042390P10637

[illegible][illegible]Examiner
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INFORMATION DISCLOSURE

STATEMENT BY APPLICANT

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Application Number	09/739,929
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Group Art Unit	2818
Examiner Name	Hoang, Quoc Dinh
Attorney Docket Number	042390P10637

Sheet	2	of	2
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OTHER ART - NO PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	T ²
		"Corrosion and Electromigration-Resistant High-Conductivity VLSI Interconnects" IBM Technical Disclosure Bulletin, IBM Corp., New York, Vol. 26, No. 4, April 1, 1993, pages 335-336, XP000364537	
		"CU(SN) Alloys for Chip and Package Interconnects", IBM Technical Disclosure Bulletin, IBM Corp., New York, Vol. 37, No. 10, October 1, 1994, pages 61, XP000475580	
		International Search Report (PCT/US 01/43915)	

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